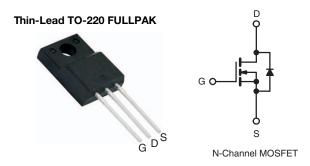
Vishay Siliconix

## **EF Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650	)
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V	0.176
Q <sub>g</sub> (Max.) (nC)	84	
Q <sub>gs</sub> (nC)	14	
Q <sub>gd</sub> (nC)	24	
Configuration	Sing	le



### **FEATURES**

Fast body diode MOSFET using E series technology



COMPLIANT

Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RBM</sub>

• Low figure-of-merit (FOM): Ron x Qg

• Low input capacitance (Ciss)

- Increased robustness due to low Q<sub>rr</sub>
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High intensity discharge (HID)
  - Light emitting diodes (LEDs)
- Consumer and computing
  - ATX power supplies
- Industrial
  - Welding
  - Battery chargers
- Renewable energy
  - Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- Applications using the following topologies
  - LLC
  - Phase shifted bridge (ZVS)
  - 3-level inverter
  - AC/DC bridge

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA21N60EF-E3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage	rce Voltage V <sub>DS</sub> 600		V		
Gate-Source Voltage		$V_{GS}$	± 30	V	
Continuous Drain Current (T,I = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$		21	
Continuous Drain Current (1) = 130 C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	14	Α
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	53	
Linear Derating Factor				0.28	W/°C
Single Pulse Avalanche Energy b		E <sub>AS</sub>	367	mJ	
Maximum Power Dissipation			P <sub>D</sub>	35	W
Operating Junction and Storage Temperature Range	Э		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope	$T_{J} = 1$	125 °C	dV/dt	70	\//no
Reverse Diode dV/dt <sup>d</sup>	•		av/at –	20	- V/ns
Soldering Recommendations (Peak Temperature) c	for	10 s		300	°C

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 5.1 A.
- c. 1.6 mm from case.

S15-1194-Rev. B, 25-May-15

d.  $I_{SD} \le I_D$ , dI/dt = 100 A/ $\mu$ s, starting  $T_J = 25$  °C.



## Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	3.6	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	_	0.59	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Cata Sauraa Laakaga	1	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V	-	-	± 1	μΑ
Zero Gate Voltage Drain Current		V <sub>DS</sub> =	= 480 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 11 A	-	0.153	0.176	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 11 A		-	7	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	2030	-	pF
Output Capacitance	C <sub>oss</sub>	1	V <sub>DS</sub> = 100 V, f = 1 MHz		105	-	
Reverse Transfer Capacitance	C <sub>rss</sub>				5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 V to 480 V		-	86	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	299	-	
Total Gate Charge	Qg			-	56	84	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 11 \text{ A}, V_{DS} = 480 \text{ V}$	-	14	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	24	-	
Turn-On Delay Time	t <sub>d(on)</sub>			_	21	42	
Rise Time	t <sub>r</sub>	$V_{DD} = 480 \text{ V}, I_{D} = 11 \text{ A}$		-	31	62	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 9$	$R_g = 9.1 \Omega, V_{GS} = 10 V$		59	89	ns -
Fall Time	t <sub>f</sub>	1		-	27	54	
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		-	0.56	-	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	Is	MOSFET syml showing the	MOSFET symbol showing the		-	21	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	53	- A
Diode Forward Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 11  \text{A},  V_{GS} = 0  \text{V}$		-	0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>				135	270	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 11 \text{A},$ dl/dt = 100 A/µs, $V_R = 25 \text{V}$		-	0.76	1.52	μC
Reverse Recovery Current	I <sub>RRM</sub>			-	11	-	A

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

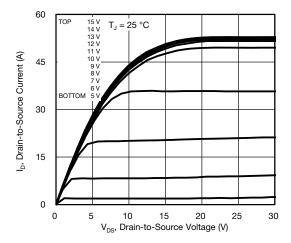


Fig. 1 - Typical Output Characteristics, T<sub>J</sub> = 25 °C

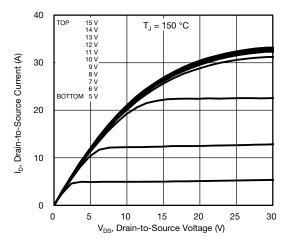


Fig. 2 - Typical Output Characteristics,  $T_J$  = 150 °C

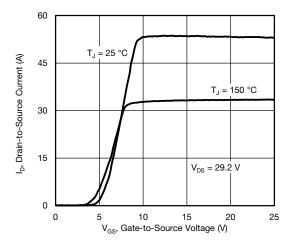


Fig. 3 - Typical Transfer Characteristics

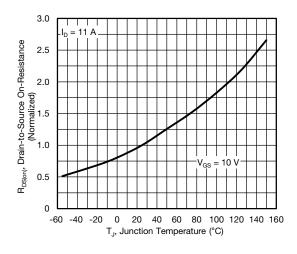


Fig. 4 - Normalized On-Resistance vs. Temperature

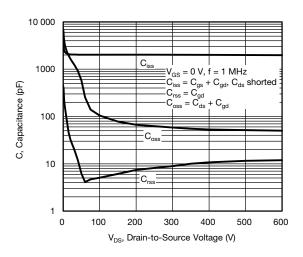


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

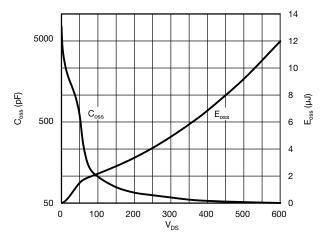


Fig. 6 - Coss and Eoss vs. VDS



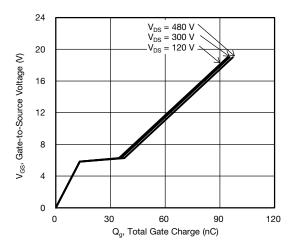


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

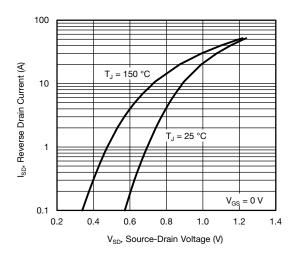


Fig. 8 - Typical Source-Drain Diode Forward Voltage

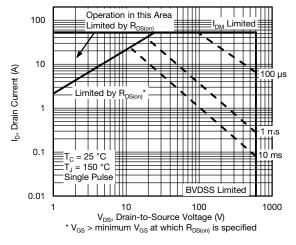


Fig. 9 - Maximum Safe Operating Area

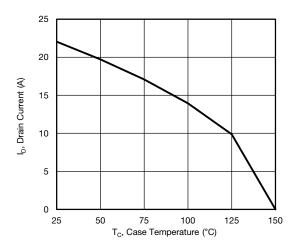


Fig. 10 - Maximum Drain Current vs. Case Temperature

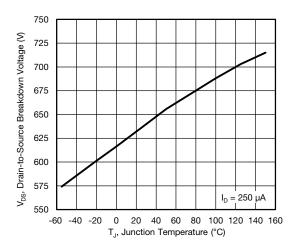


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature



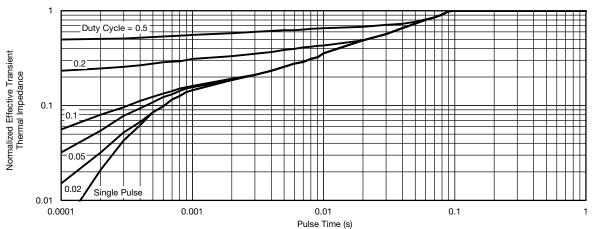


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

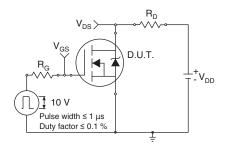


Fig. 13 - Switching Time Test Circuit

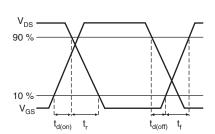


Fig. 14 - Switching Time Waveforms

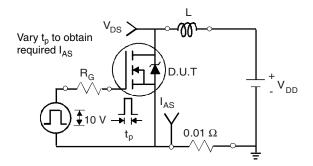


Fig. 15 - Unclamped Inductive Test Circuit

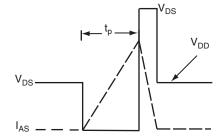


Fig. 16 - Unclamped Inductive Waveforms

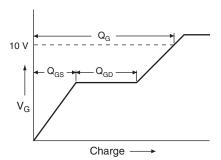


Fig. 17 - Basic Gate Charge Waveform

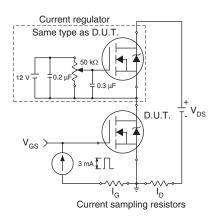
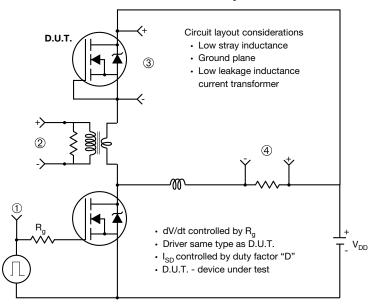


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



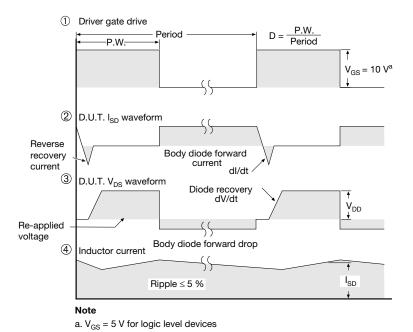


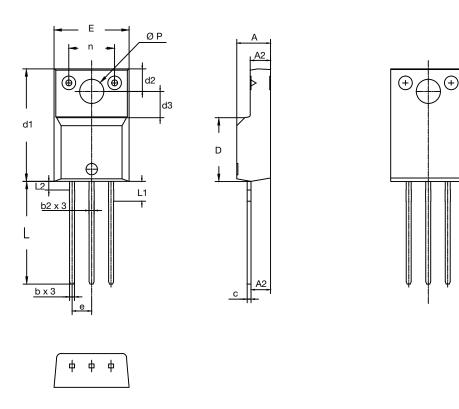
Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**



SYMBOL	DIMENSIONS				
	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.50	2.70	0.098	0.106	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	-	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.40	3.60	0.134	0.142	
Е	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	2.50	2.80	0.098	0.110	
L2	-	1.20	-	0.047	
n	6.05	6.15	0.238	0.242	
ØP	3.00	3.40	0.118	0.134	

Revision: 12-Oct-15 1 Document Number: 62649



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